EXPLANATION OF REFERENCE

20: substrate, 30: TFT substrate, 32: sealant, 33: liquid crystal, 34: barrier layer, 35, marker, 40: control device, 42: imaging means, 43: head, 45: marker, 50: substrate, 51: mask, 52: substance, 54: nozzle, 55: droplet, 56: pattern, 57: pattern, 59: pattern, 60: nozzle, 61: droplet, 62: pattern, 63: pattern, 70: substrate, 71a: mask, 71b: mask, 71c: mask, 72: substance, 76: pattern, 77: pattern, 100: substrate, 101: mask, 103: gate electrode layer, 104: gate electrode layer, 105: gate electrode layer, 106: gate electrode layer, 107: semiconductor layer, 108: semiconductor layer, 109: n-type semiconductor layer, 110: n-type semiconductor layer, 111: drain electrode layer, 112: drain electrode layer, 113: drain electrode layer, 114: drain electrode layer, 116: gate insulating layer, 117: electrode layer, 121: insulating layer, 122: electroluminescent layer, 123: electrode layer, 125: mask, 126: high wettability region, 127: gate electrode layer, 145: contact hole, 160: connecting wiring layer, 161: connecting wiring layer, 162: connecting wiring layer, 163: connecting wiring layer, 180a: nozzle, 180b: nozzle, 301: low wettability region, 303: gate electrode layer, 305: gate insulating layer, 307: n-type semiconductor layer, 308: drain electrode layer, 311: pixel electrode layer, 312: insulating layer, 320: liquid crystal layer, 321: insulating layer, 322: colored layer, 323: conductive layer, 324: opposing substrate, 325: polarizing plate, 330: drain electrode layer, 345: contact hole, 350: pattern, 351: substance, 360: low wettability substance, 380: nozzle, 381: nozzle, 401: TFT. 402: capacitor element, 403: TFT, 404: TFT, 405: light-emitting element, 406: TFT, 410 signal line,

411: power source line, 412: power source line, 413: power source line, 414: scanning line, 415: power source line, 416: scanning line, 441: switching TFT, 442: capacitor element, 443: driver TFT, 444: light-emitting element, 445: TFT, 450: signal line, 451: power source line, 452: power source line, 453: scanning line, 454: scanning line, 462: drain electrode, 463: electrode, 464: electroluminescent layer, 465: electrode, 471: drain electrode, 472: electrode, 473: electroluminescent layer, 474: electrode, 480: substrate, 481: thin film transistor, 484: electrode, 485: electroluminescent layer, 486: electrode, 500: block, 501: TFT, 502: TFT, 503: light-emitting element, 504: capacitor element, 505: drain wiring layer, 554: common electric potential line, 555: common electric potential line, 556: common electric potential line, 557: common electric potential line, 561: protective diode, 562: protective diode, 563: protective diode, 564: protective diode, 601: TFT, 620: TFT, 901: buffer circuit, 902: pixel, 1400: substrate, 1403: droplet discharging means, 1404: imaging means, 1405: head, 1406: dotted line, 1407: controlling means, 1408: recording medium, 1409: image processing means, 1410: computer, 1411: marker, 1412: head, 1413: material supply source, 1414: material supply source, 2001: housing, 2002: display panel, 2003: main screen, 2004: modem, 2005: receiver, 2006: remote control device, 2007: display portion, 2008: sub screen, 2009: speaker portion, 2101: main body, 2102: housing, 2103: display portion, 2104: key board, 2105: external connecting port, 2106: pointing mouse, 2201: housing, 2203: display portion A, 2204: display portion B, 2206: operation key, 2207: speaker portion, 2301: main body, 2302: audio output portion, 2303: audio input portion, 2304: display

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portion, 2305: operation switch, 2306: antenna, 2401: main body, 2402: display portion, 2405: remote control receiving portion, 2406: image receiving portion, 2407: battery, 2408: audio input portion, 2409: operation key, 2410: eye contact portion, 2600: TFT substrate, 2601: opposing substrate, 2602: sealant, 2603: pixel portion, 2604: liquid crystal layer, 2605: colored layer, 2606: polarizing plate, 2607: polarizing plate, 2608: driver circuit, 2609: flexible wiring substrate, 2610: cold-cathode tube, 2611: reflecting plate, 2612: circuit substrate, 2613: lens film, 2700: substrate, 2701: pixel portion, 2702: pixel, 2703: scanning line side input terminal, 2704: signal line side input terminal, 2750: FPC, 2751: driver IC, 2800: TFT substrate, 2801: protective circuit portion, 2802: TFT, 2803: TFT, 2804: light-emitting element, 2805: light-emitting element, 2806a: spacer, 2806b: spacer, 2807a: colored layer, 2807b: colored layer, 2807c: colored layer, 2809: external circuit, 2810: wiring substrate, 2811: circuit substrate, 2812: radiator plate, 2813: heat pipe, 2820: sealing substrate, 3300: device substrate, 3301: pixel portion, 3302: pixel, 3303: sealant, 3305: drying agent, 3307: filler, 3308: source wiring layer, 3310: sealing substrate, 3350: FPC, 3601: antireflection film, 3602: polarizing plate, 3603: retardation film, 3604: retardation film, 3604a: drying agent, 3604b: drying agent, 3605: insulating layer, 3306a: gate wiring layer, 3306b: gate wiring layer, 3700: substrate, 3701: pixel portion, 3702: scanning line side driver circuit, 3704: signal line side input terminal, 4700: substrate, 4701: pixel portion, 4702: scanning line driver circuit, and 4704: signal line driver circuit.